

## QSFP28-100G-DCO-0DBM-AO

MSA (with select systems) TAA 100GBase-ZR QSFP28 Transceiver (SMF, 1528.77nm to 1567.13nm, 80km, LC, DOM, 0 to 70C) 0dbm

### Features

- Hot-Pluggable QSFP28 Form Factor
- High Tx Output Power 0dBm for Compatibility with ROADM Line Systems
- IEEE 100G Ethernet (CAUI-4) Compliant Host Interface
- Operating Temperature: 0 to 70 Celsius
- Power Dissipation: 6.0W
- Full C-Band Tunable, 50GHz/100GHz Spacing
- Tuning box is required for operation
- RoHS Compliant and Lead-Free
- Please contact your sales representative for specific system information



### Applications

- Duplex Mux
- 100GBase Ethernet

### Product Description

This MSA compliant (with select systems) high Tx power 0dBm QSFP28 transceiver provides 100GBase-ZR throughput up to 80km over single-mode fiber (SMF) using a wavelength of 1528.77nm to 1567.13nm via an LC connector. It can operate at temperatures between 0 and 70C. It has been programmed, uniquely serialized, and tested for data-traffic and application to ensure that it will initialize and perform identically. All of our transceivers comply with Multi-Source Agreement (MSA) standards to provide seamless network integration. Additional product features include Digital Optical Monitoring (DOM) support which allows access to real-time operating parameters. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

AddOn's transceivers are RoHS compliant and lead-free.

TAA refers to the Trade Agreements Act (19 U.S.C. & 2501-2581), which is intended to foster fair and open international trade. TAA requires that the U.S. Government may acquire only "U.S.-made or designated country end products."



### Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
DC Supply Voltage	Vcc	-0.3		3.6	V	
Low-Speed I/O Voltages		-0.3		3.6	V	
Storage Temperature	Tstg	-40		85	°C	
Operating Case Temperature	Long-Term	Tc	0	70	°C	1
	Short-Term <96 Hours		-5	75	°C	
Operating Relative Humidity	RH	5		95	%	
Rx Input Power	PRx,in			10	dBm	
ESD Damage Threshold Human Body Model (HBM)	DC Pins		2000		V	
	RF Pins		1000		V	

### Notes:

1. Central office applications.
2. Stresses in excess of the Absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the datasheet. Exposure to Absolute Maximum Ratings for extended periods of time can adversely affect device reliability. Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

### Host Interface Modes

Host Interface ID [18]	Host Interface Description [18]	Modulation	Forward Error Correction Code	Nominal Symbol Rate (GBd)	Supported Line Interface IDs [18]
65 [8]	CAUI-4 C2M without FEC	NRZ	None	25.78125	68, 192, 193
66 [8]	CAUI-4 C2M with RS(528,514) FEC	NRZ	RS(528,514)	25.78125	68, 192, 193

## Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
<b>Power Supply – General</b>						
<b>Power Supply Voltage</b>		3.135	3.3	3.465	V	Including ripple, droop, and noise below 100kHz
<b>Host RMS Noise Output</b>				25	mV	10Hz - 10MHz
<b>Module RMS Noise Output</b>				15	mV	10Hz - 10MHz
<b>Module Supply Noise Tolerance</b>	PSNRmod			66	mV	10Hz - 10MHz, peak-to-peak
<b>Module In-Rush</b>	Tip			50	μs	Instantaneous peak duration
	Tinit			500	ms	Initialization time
<b>Power Supply – Low-Power Mode</b>						
<b>Power Dissipation</b>	Plp			1.5	W	
<b>Power Supply Current</b>	Icc,ip,lp			600	mA	Instantaneous peak current
	Icc,sp,lp			495	mA	Sustained peak current
	Icc,lp			478	mA	1, Steady state current
<b>Power Supply – High-Power Mode – 2.4ns/nm CD</b>						
<b>Power Dissipation</b>	Php		5.5	6.2	W	
<b>Power Supply Current</b>	Icc,ip,hp			2480	mA	Instantaneous peak current
	Icc,sp,hp			2046	mA	Sustained peak current
	Icc,hp			1978	mA	1, Steady state current
<b>Low-Speed I/O</b>						
<b>Clock Frequency (SCL)</b>	fSCL		400		kHz	Default
			1000			Fast-mode+
<b>Output Voltage (SCL and SDA)</b>	VOL	0.0		0.4		Output low
	VOH	Vcc-0.5		Vcc+0.3		Output high
<b>Input Voltage (SCL and SDA)</b>	VIL	-0.3		0.3×Vcc	V	Input low
	VIH	0.7×Vcc		Vcc+0.5		Input high
<b>Capacitance for SCL and SDA I/O Signal</b>	Ci			14	pF	
<b>Total Bus Capacitive Load for SCL and SDA</b>	Cb			100	pF	2, 3.0kΩ pull-up resistor, maximum
				200		2, 1.6kΩ pull-up resistor, maximum
<b>Input Voltage/Current, LPMode/TxDis, ResetL, and ModSelL</b>	VIL	-0.3		0.8	V	Input voltage, low
	VIH	2.0		Vcc+0.3		Input voltage, high
	Iin	-365		125	μA	Input current, 0V < VIN < Vcc
<b>Output Voltage, ModPrsL, and IntL/RxLOSL</b>	VOL	0.0		0.4	V	Output low, IOL = 2mA
	VOH	Vcc-0.5		Vcc+0.3		Output high, 10kΩ pull-up resistor to Host_Vcc

### Notes:

1. The module will stay within its advertised power class for all supply voltages.
2. For 1000kHz clock rate.

## Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
<b>Power Supply – General</b>						
<b>Symbol Rate</b>	Rbaud		27.95		GBd	
<b>Modulation Format</b>		DP-DQPSK				
<b>Channel Frequency Range</b>	Vc	191.4	193.7	196.1	THz	100GHz grid
	Vc	191.35	193.7	196.1	THz	50GHz grid
<b>Channel Spacing</b>	ΔVc		100		GHz	100GHz grid
	ΔVc		50		GHz	50GHz grid
<b>Frequency Accuracy</b>	δVc	-1.8		1.8	GHz	
<b>Laser Intrinsic Linewidth</b>	LW			500	kHz	Calculated based on FM noise Power Spectral Density (PSD) measurement
<b>Side-Mode Suppression Ratio</b>	SMSR	40			dB	No modulation
<b>Relative Intensity Noise</b>	RIN			-140	dB/Hz	Peak over 0.2GHz < f < 10GHz
<b>Transmitter</b>						
<b>Tx Output Power</b>	PTx,out	0			dBm	
<b>Tx Output Power Monitor Range</b>	PTx,mon	-2		4	dBm	
<b>Tx Output Power Monitor Accuracy</b>	δPTx,mon	-1.5		1.5	dB	Tx optical power monitor reading relative to actual Tx output power
<b>Tx Output Power During Tuning or When Tx is Disabled</b>	PTx,dark			-35	dBm	
<b>Tx Spectral Excursion</b>		-15		15	GHz	ITU-T G.698.2 §7.2.3 [11]
<b>Tx Output Power Imbalance Between X and Y Polarizations</b>	ΔPX/Y			1.5	dB	
<b>Tx XY Skew</b>				6.0	ps	
<b>Tx IQ Offset</b>				-25	dB	
<b>Tx IQ Imbalance</b>				1.0	dB	
<b>Tx Quadrature Error</b>		-7.0		7.0	°	
<b>Tx IQ Skew</b>				1.5	ps	
<b>Tx Error Vector Magnitude Mask Ratio</b>				23	%	ITU-T G.698.2 §7.2.12 [11], with 24dB/12.5GHz noise loading
<b>Tx In-Band Optical Signal to Noise Ratio</b>	OSNRin	39			dB/12.5GHz	Under modulation,  Δf  < 60GHz
<b>Tx Out-of-Band Optical Signal to Noise Ratio</b>	OSNRout	30			dB/12.5GHz	Under modulation,  Δf  > 150GHz
<b>Tx Reflectance</b>				-20	dB	
<b>Receiver</b>						
<b>Rx Total Input Power</b>	PRx,tot	-30		3	dBm	Broadband
<b>Rx Signal Input Power (Amplified)</b>	PRx,sig	-18		1	dBm	Full Rx OSNR tolerance
		-22		3	dBm	1

<b>Rx OSNR Tolerance</b>	<b>100G DQPSK SC</b>		16.5			dB/12.5GHz	2
	<b>100G DQPSK RS</b>		21.5				
<b>CD Tolerance</b>				2.4	ns/nm	Default, OSNR penalty < 0.5dB	
				6.0		3	
<b>PMD Tolerance</b>			10	Ps	4		
<b>DGD Tolerance</b>			30	Ps	4		
<b>Tolerance to Change in SOP</b>			50	krad/s	4		
<b>PDL OSNR Penalty</b>	<b>1dB PDL</b>			0.5	dB/12.5GHz	Change in principal state of polarization < 1rad/ms	
	<b>2dB PDL</b>			1.0			
	<b>4dB PDL</b>			3.0			
<b>Rx Signal Input Power Transient Amplitude</b>		-3		3	dB	5	
<b>Rx Signal Input Power Transient Rise/Fall Time</b>		100			μs	6	
<b>Colorless Drop OSNR Penalty</b>				0.5	dB	7	
<b>Colorless Drop Adjacent Channel Crosstalk Penalty</b>				0.2	dB	8	
<b>Rx Signal Input Power (Unamplified)</b>	<b>100G DQPSK SC</b>		-30		1	dBm	OSNR > 35dB/12.5GHz
	<b>100G DQPSK RS</b>		-24		1		
<b>Rx Signal Input Power Monitor Range</b>	PRx,mon(s)	-21		3	dBm		
<b>Rx Signal Input Power Monitor Accuracy</b>	δPRx,mon(s)	-2.5		2.5	dB		
<b>Rx Total Input Power Monitor Range</b>	PRx,mon(t)	-21		6	dBm		
<b>Rx Total Input Power Monitor Accuracy</b>	δPRx,mon(t)	-2.0		2.0	dB		
<b>Rx Reflectance</b>				-20	dB		

**Notes:**

1. Extended range. Rx signal input power range over which performance can be guaranteed with <1dB OSNR penalty relative to the Rx OSNR tolerance limit.
2. Back-to-back, PRx,sig > -18dBm. Rx OSNR tolerance for Carrier Frequency Offset |CFO| < 1GHz. Up to 1dB penalty for worst-case |CFO| = 3.6GHz.
3. Extended, OSNR penalty < 1.0dB. Power dissipation will increase by approximately 0.2W if extended CD compensation is enabled.
4. OSNR penalty < 0.5dB.
5. Peak excursion from steady state, transient within Rx signal input power (amplified) range, and OSNR penalty <0.5dB.
6. Rise/fall time for the above peak excursion, OSNR penalty <0.5dB.
7. Rx total input power to signal input power ratio < 12dB. 4. Receiver is able to tolerate the specified ratio of total power of crosstalk channels and ASE to signal power with the specified OSNR penalty. Does not include contribution from adjacent channel crosstalk. No single channel power exceeding signal channel power by more than 1dB shall be included. Measured at Rx signal input power -6dBm.
8. Measured at the Rx OSNR limit, 50GHz channel spacing, both adjacent channels <1dB higher power than signal channel.

## SFF-8636 Management Interface

Parameter	Symbol	Min.	Max.	Unit	Conditions	Notes
Initialization Time			120	s	Time from power on or hot plug until the module is fully functional (assuming LPMode pulled low by the host).	2, 3
Reset Init Assert Time		10		μs	Minimum pulse time on the ResetL signal to initiate a module reset.	
Serial Bus Hardware Ready Time			2	s	Time from power on until the module responds to data transmission over the 2-wire serial bus.	2
Monitor Data Ready Time			2	s	Time from power on to Data_Not_Ready, Byte 2 bit 0, cleared to 0, and IntL output pulled low.	2
Reset Assert Time			120	s	Time from a rising edge on the ResetL input until the module is fully functional.	3
LPMode/TxDis Mode Change Time			100	ms	Time to change between LPMode and TxDis modes of the dual-mode signal LPMode/TxDis.	
LPMode Assert Time			100	ms	Time from when the host releases LPMode to high until module power consumption reaches Power Class 1.	
LPMode De-Assert Time			120	s	Time from when the host pulls LPMode low until the module is fully functional.	3
IntL/RxLOSL Mode Change Time			100	ms	Time to change between IntL and RxLOSL modes of the dual-mode signal IntL/RxLOSL.	
IntL Assert Time			200	ms	Time from occurrence of condition triggering an interrupt until IntL is low.	
IntL De-Assert Time			500	μs	Time from clear on read operation of associated flag until module releases IntL to high. This includes the time to clear Rx LOS, Tx Fault, and other flag bits.	4
RxLOSL Assert Time			1	ms	Time from optical loss of signal to RxLOSL signal pulled low by the module.	
RxLOSL De-Assert Time			15	ms	Time from optical signal above the LOS de-assert threshold to when the module releases the RxLOSL signal to high.	
Tx Fault Assert Time			200	ms	Time from Tx Fault state to Tx Fault bit set to 1 and IntL pulled low by the module.	
Flag Assert Time			200	ms	Time from condition triggering flag to associated flag bit set to 1 and IntL pulled low by the module.	
Mask Assert Time			100	ms	Time from mask bit set to 1 until the module is prevented from pulling IntL low when the associated flag is set high.	1
Mask De-Assert Time			100	ms	Time from mask bit cleared to 0 until module is enabled to pull IntL low when the associated flag is set high.	1
<b>I/O Timing for Squelch &amp; Disable</b>						
Rx Squelch Assert Time			15	ms	Time from loss of Rx input signal until the squelched output condition is reached.	
Rx Squelch De-Assert Time			15	ms	Time from resumption of Rx input signals until normal Rx output condition is reached.	
Tx Squelch Assert Time			400	ms	Time from loss of Tx input signal until the squelched output condition is reached.	
Tx Squelch De-Assert Time			10	s	Time from resumption of Tx input signal until the normal Tx output condition is reached.	
Tx Disable Assert Time			1	ms	Time from Tx_Disable bit is set to 1 until optical output falls below 10% of nominal.	1
Tx Disable De-Assert Time			10	s	Time from Tx Disable bit cleared to 0 until optical output rises above 90% of nominal.	1

<b>Rx Output Disable Assert Time</b>		100	ms	Time from Rx Output Disable bit set to 1 until Rx output falls below 10% of nominal.	1
<b>Rx Output Disable De-Assert Time</b>		100	ms	Time from Rx Output Disable bit cleared to 0 until Rx output rises above 90% of nominal.	1
<b>Squelch Disable Assert Time</b>		100	ms	This applies to Rx and Tx Squelch and is the time from bit cleared to 0 until squelch functionality is disabled.	1
<b>Squelch Disable De-Assert Time</b>		100	ms	This applies to Rx and Tx Squelch and is the time from bit set 1 until squelch functionality is enabled.	1

**Notes:**

1. Measured from the rising edge of SDA during STOP sequence of write transaction.
2. “Power On” is defined as the instant when supply voltages reach and remain at or above the minimum level specified.
3. “Fully Functional” is defined as the module being ready to transmit and receive valid signals and all management interface data, including monitors, being valid. It is indicated after “Reset” or “Hot Plug” by the module releasing IntL to “high” after the host has read a 0 from the Data\_Not\_Ready flag bit.
4. Measured from rising edge of the SDA during STOP sequence of read transaction.

**Optical Timing Characteristics**

Parameter	Symbol	Min.	Max.	Unit	Conditions	Notes
<b>Tx Turn On Time</b>			10	s	Warm Start	1
			120	s	Cold Start	
<b>Rx Acquisition Time</b>			30	ms	Warm Start	
			120	s	Cold Start	
<b>Tx/Rx Channel Tuning Time</b>		10	30	s		

**Notes:**

1. Assumes the Tx/Rx laser is already tuned to the correct frequency.

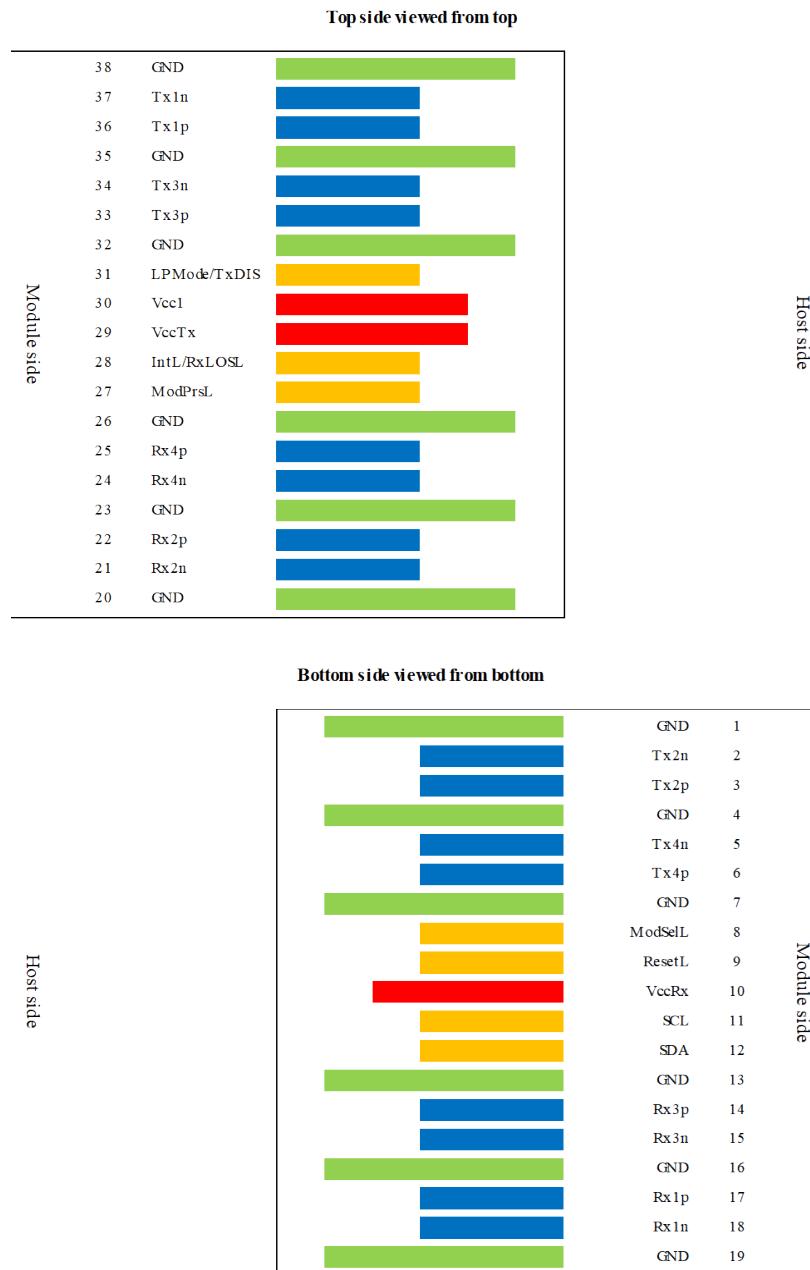
## Pin Descriptions

Pin	Logic	Symbol	Name/Description	Plug Sequence	Notes
1		GND	Module Ground.	1	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	3	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	3	
4		GND	Module Ground.	1	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	3	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	3	
7		GND	Module Ground.	1	1
8	LVTTI-I	ModSelL	Module Select.	3	
9	LVTTI-I	ResetL	Module Reset.	3	
10		VccRx	+3.3V Receiver Power Supply.	2	2
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock.	3	
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data.	3	
13		GND	Module Ground.	1	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	3	
15	CML-O	Rx3-	Receiver Inverted Data Output.	3	
16		GND	Module Ground.	1	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	3	
18	CML-O	Rx1-	Receiver Inverted Data Output.	3	
19		GND	Module Ground.	1	1
20		GND	Module Ground.	1	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	3	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	3	
23		GND	Module Ground.	1	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	3	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	3	
26		GND	Module Ground.	1	1
27	LVTTI-O	ModPrsL	Module Present.	3	
28	LVTTI-O	IntL/RxLOSL	Interrupt. Optionally configurable as RxLOSL via the management interface (SFF-8636).	3	
29		VccTx	+3.3V Transmitter Power Supply.	2	2
30		Vcc1	+3.3V Power Supply.	2	2
31	LVTTI-I	LPMode/TxDis	Low-Power Mode. Optionally configurable as TxDis via the management interface (SFF-8636).	3	
32		GND	Module Ground.	1	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	3	
34	CML-I	Tx3-	Transmitter Inverted Data Input.	3	
35		GND	Module Ground.	1	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	3	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	3	
38		GND	Module Ground.	1	1

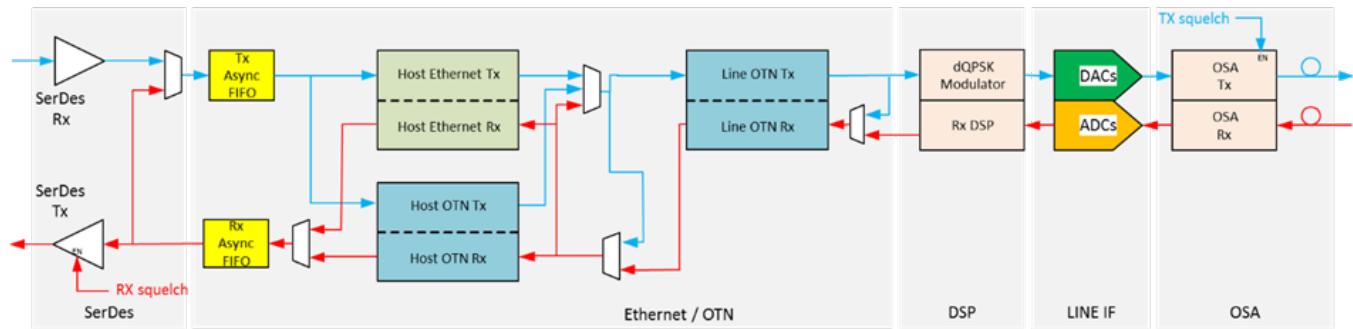
## Notes:

1. GND is the symbol for signal and supply (power) common for the module. All are common within the module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
2. VccRx, Vcc1, and VccTx are applied concurrently and may be internally connected within the module in any combination.
3. Plug Sequence specifies the mating sequence of the host connector and module. The sequence is 1, 2, and 3. See figure below for pad locations.

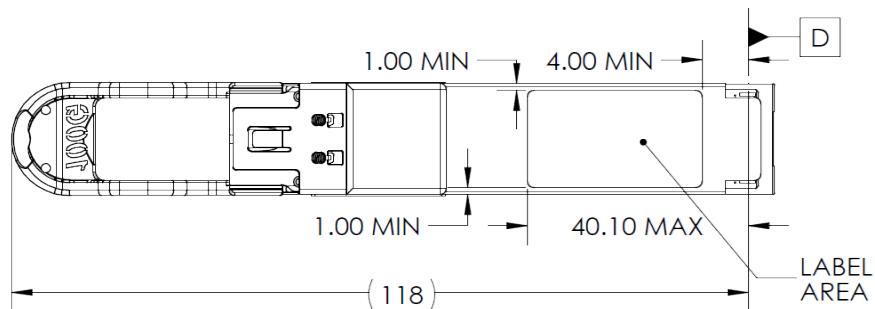
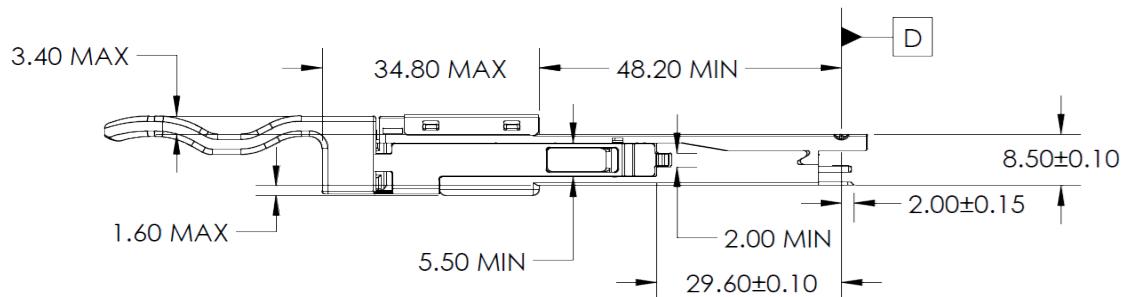
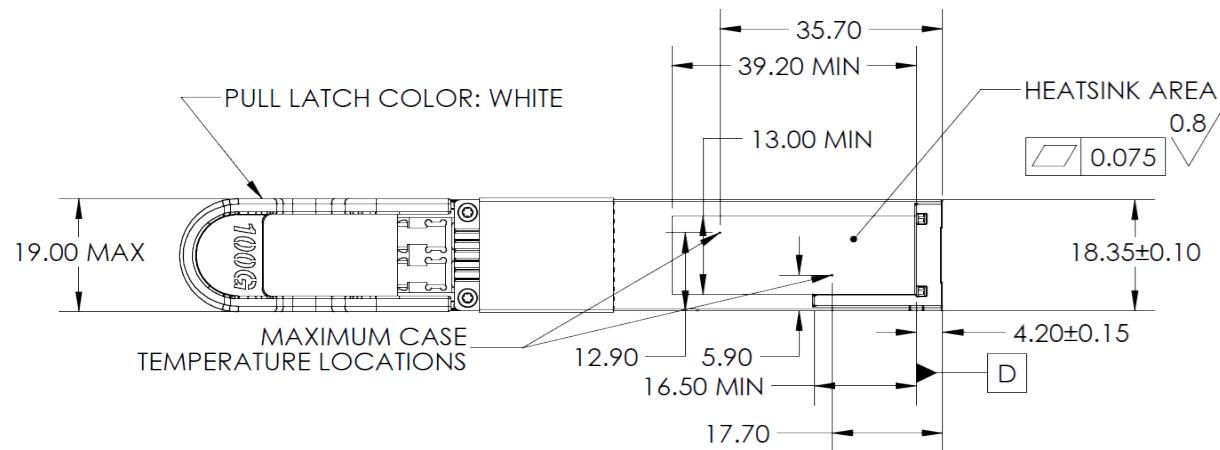
## Electrical Pad Layout



## Block Diagram



## Mechanical Specifications



## About AddOn Networks

In 1999, AddOn Networks entered the market with a single product. Our founders fulfilled a severe shortage for compatible, cost-effective optical transceivers that compete at the same performance levels as leading OEM manufacturers. Adhering to the idea of redefining service and product quality not previously had in the fiber optic networking industry, AddOn invested resources in solution design, production, fulfillment, and global support.

Combining one of the most extensive and stringent testing processes in the industry, an exceptional free tech support center, and a consistent roll-out of innovative technologies, AddOn has continually set industry standards of quality and reliability throughout its history.

Reliability is the cornerstone of any optical fiber network and is engrained in AddOn's DNA. It has played a key role in nurturing the long-term relationships developed over the years with customers. AddOn remains committed to exceeding industry standards with certifications from ranging from NEBS Level 3 to ISO 9001:2005 with every new development while maintaining the signature reliability of its products.



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